

BONDING STRUCTURE WITH PILLAR AND CAP

Appl. No. : 10/055,580 Confirmation No. 6089
Applicant : Jin-Yuan Lee,
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Examiner : Mitchell, James M
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Customer No. : 27765

Commissioner for Patents
P.O. Box 1450
Alexandria VA 22313-1450

AMENDMENT

Sir:

- 5 The Office Action mailed Jul. 25, 2006 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks:

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 3 of this paper.

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Remarks/Arguments begin on page 10 of this paper.